

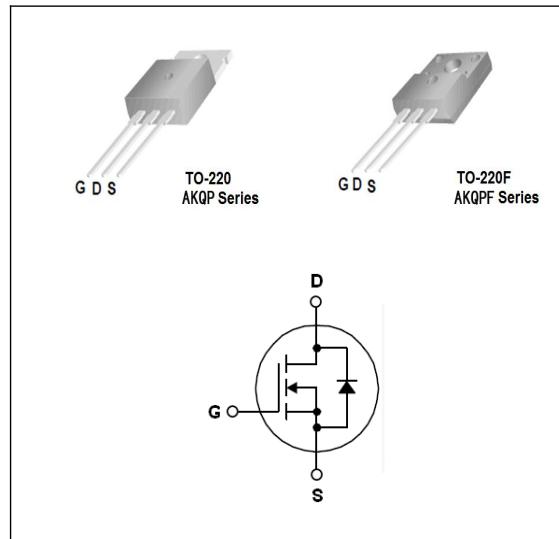
## 900V 4A N-channel Enhancement Mode Power MOSFET

### Description

The AKT4N90FC / AKT4N90TC is an high blocking voltage N-Channel power MOSFET. This device provide excellent performance for high voltage power supplies or pulse circuits.

### Features

- Lower on-Resistance:  $R_{DS(on)}=2.3\Omega$
- Good Stability and Uniformity with High  $E_{AS}$
- 100% Avalanche Test
- Special Process Technology for High ESD Capability



### Applications

- High Voltage Power Supplies
- Capacitor Discharge Applications
- Pulse Circuits

### Absolute Maximum Ratings @ $T_C=25^\circ C$ unless otherwise noted

Symbol	Parameter		SQP4N90C	SQPF4N90C	Unit
$V_{DSS}$	Drain to Source Voltage		900		V
$V_{GSS}$	Gate to Source Voltage		$\pm 30$		V
$I_D$	Drain Current	$T_C=25^\circ C$	4		A
		$T_C=100^\circ C$	2.5		A
$I_{DM}$	Pulsed Drain Current (Note1)		19		A
$P_D$	Maximum Power Dissipation	$T_C=25^\circ C$	145	46	W
	Derate above $25^\circ C$		1.12	0.40	W/ $^\circ C$
$E_{AS}$	Single Pulsed Avalanche Energy (Note 2)		550		mJ
$T_J$	Operating Junction Temperature Range		-50~+150		$^\circ C$
$T_{STG}$	Storage Temperature Range		-50~+150		$^\circ C$

### Thermal Characteristics

Symbol	Parameter	SQP4N90C	SQPF4N90C	Unit
$R_{th}(J-C)$	Thermal Resistance, Junction to case	0.88	2.68	$^\circ C/W$
$R_{th}(J-A)$	Thermal Resistance, Junction to Ambient	62.5	62.5	$^\circ C/W$

**Electrical Characteristics** @ $T_C=25\text{ }^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain to Source Breakdown Voltage	$V_{GS}=0\text{V}$ , $I_D=1\text{mA}$	900	-	-	V
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ , $I_D=250\mu\text{A}$	3.0	4.0	5.0	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}$ , $I_D=2\text{A}$	-	2.3	2.8	$\Omega$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=V_{DSS}$ , $V_{GS}=0\text{V}$	-	-	10	$\mu\text{A}$
$I_{GSS}$	Gate to Source Leakage Current	$V_{GS}=V_{GSS}$ , $V_{DS}=0\text{V}$	-	-	$\pm 100$	nA

**D-S Diode Characteristics and Maximum Rating** @ $T_C=25\text{ }^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_S$	Maximum Drain to Source Diode Forward Current		-	-	4	A
$V_{SD}$	Drain-Source Diode Forward Voltage	$V_{GS}=0\text{V}$ , $I_S=4\text{A}$	-	1.0	1.3	V
$t_{rr}$	Reverse Recovery Time		-	650	-	ns
$Q_{rr}$	Reverse Recovery Charge	$V_{GS}=0\text{V}$ , $I_S=4\text{A}$ , $dI/dt=-100\text{A}/\mu\text{s}$	-	6.5	-	nC

**Switching Characteristics** @ $T_C=25\text{ }^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on Delay Time	$I_D=4\text{A}$ , $V_{DD}=450\text{V}$ , $R_G=25\Omega$ (Note 3)	-	27	58	ns
$t_r$	Turn-on Rise Time		-	46	95	ns
$t_{d(off)}$	Turn-off Delay Time		-	40	82	ns
$t_f$	Turn-off Fall Time		-	33	75	ns
$C_{iss}$	Input Capacitance	$V_{GS}=0\text{V}$ , $V_{DS}=25\text{V}$ , $f=1.0\text{MHz}$	-	975	1100	pF
$C_{oss}$	Output Capacitance		-	86	105	pF
$C_{rss}$	Reverse Transfer Capacitance		-	2.3	4.5	pF
$Q_g$	Total Gate Charge	$I_D=4\text{A}$ , $V_{DD}=720\text{V}$ $V_{GS}=10\text{V}$ (Note 3)	-	17	22	nC
$Q_{gs}$	Gate to Emitter Charge		-	4.5	-	nC
$Q_{gd}$	Gate to Collector Charge		-	7.0	-	nC

**Note:**

1. Repetitive rating: pulse-width limited by maximum junction temperature
2.  $L=67\text{mH}$ ,  $I_D=4\text{A}$ ,  $V_G=10\text{V}$ ,  $V_{DD}=50\text{V}$
3. Essentially independent of operating temperature typical characteristics

## Typical Performance Characteristics

Fig. 1. Typical on-Resistance Characteristics

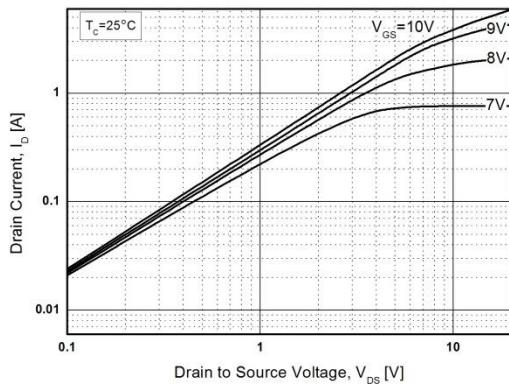


Fig. 2. Typical Transfer Characteristics

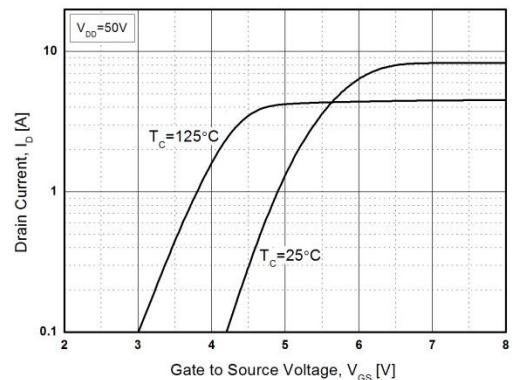


Fig. 3. Static on-Resistance vs.  $I_D$

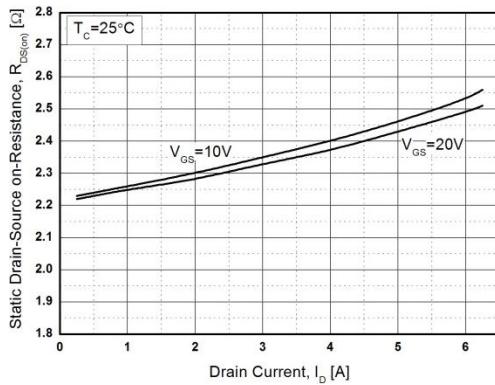


Fig. 4. Body Diode Forward Voltage vs.  $I_{DR}$

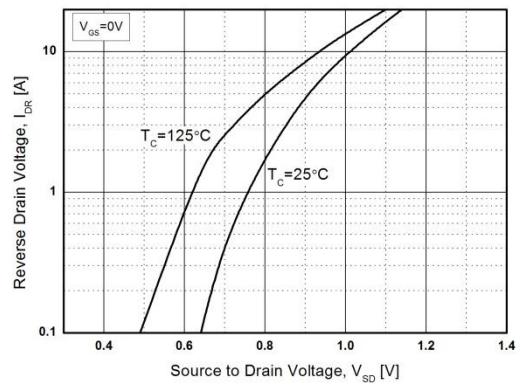


Fig. 5. Capacitance Characteristics

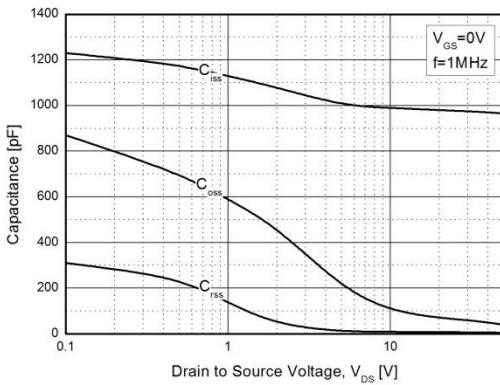
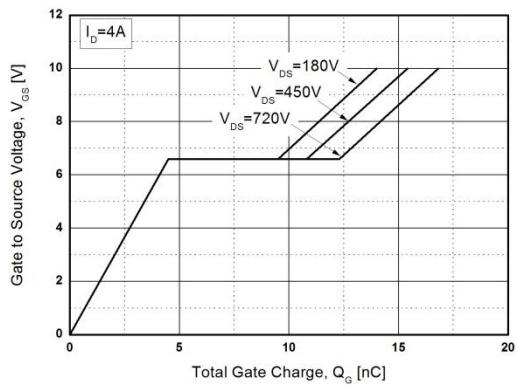


Fig. 6. Gate Charge Characteristics



## Typical Performance Characteristics

Fig. 7. Breakdown Voltage vs. Temperature

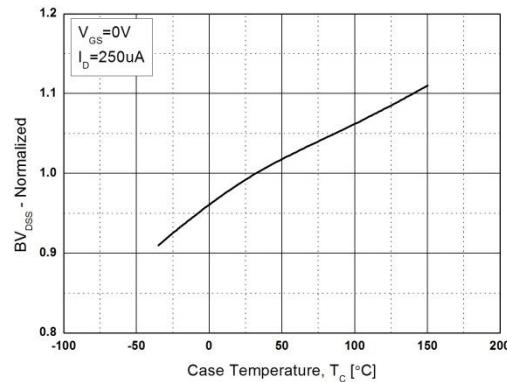


Fig. 8. Static on-Resistance vs. Temperature

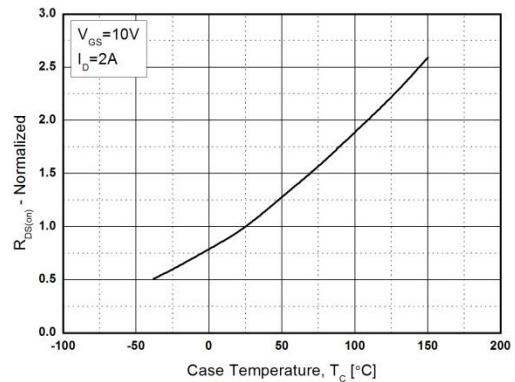


Fig. 9. Maximum Safe Operating Area-SQP4N90

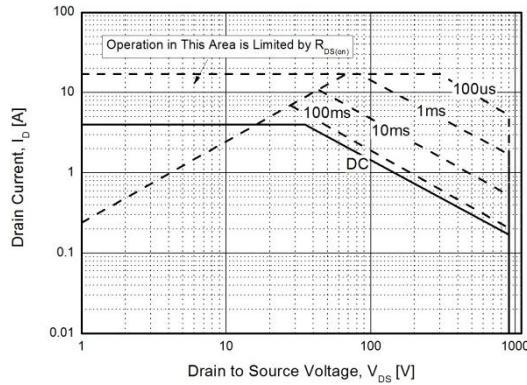


Fig. 10. Maximum Safe Operating Area-SQPF4N90

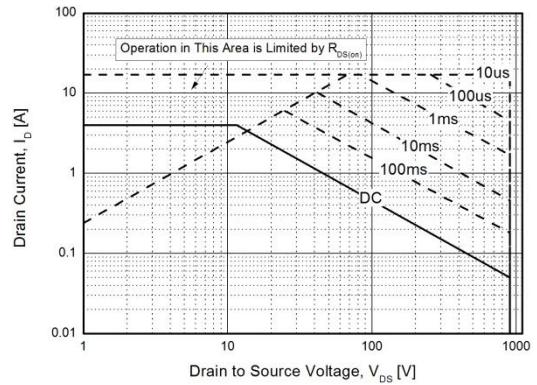
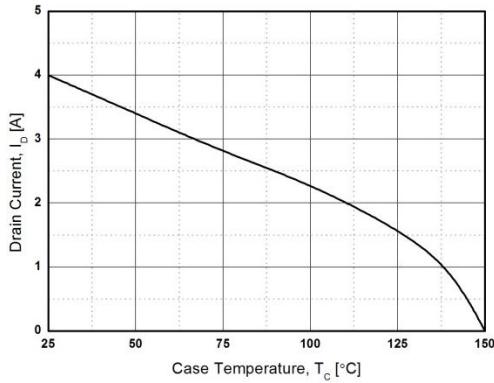
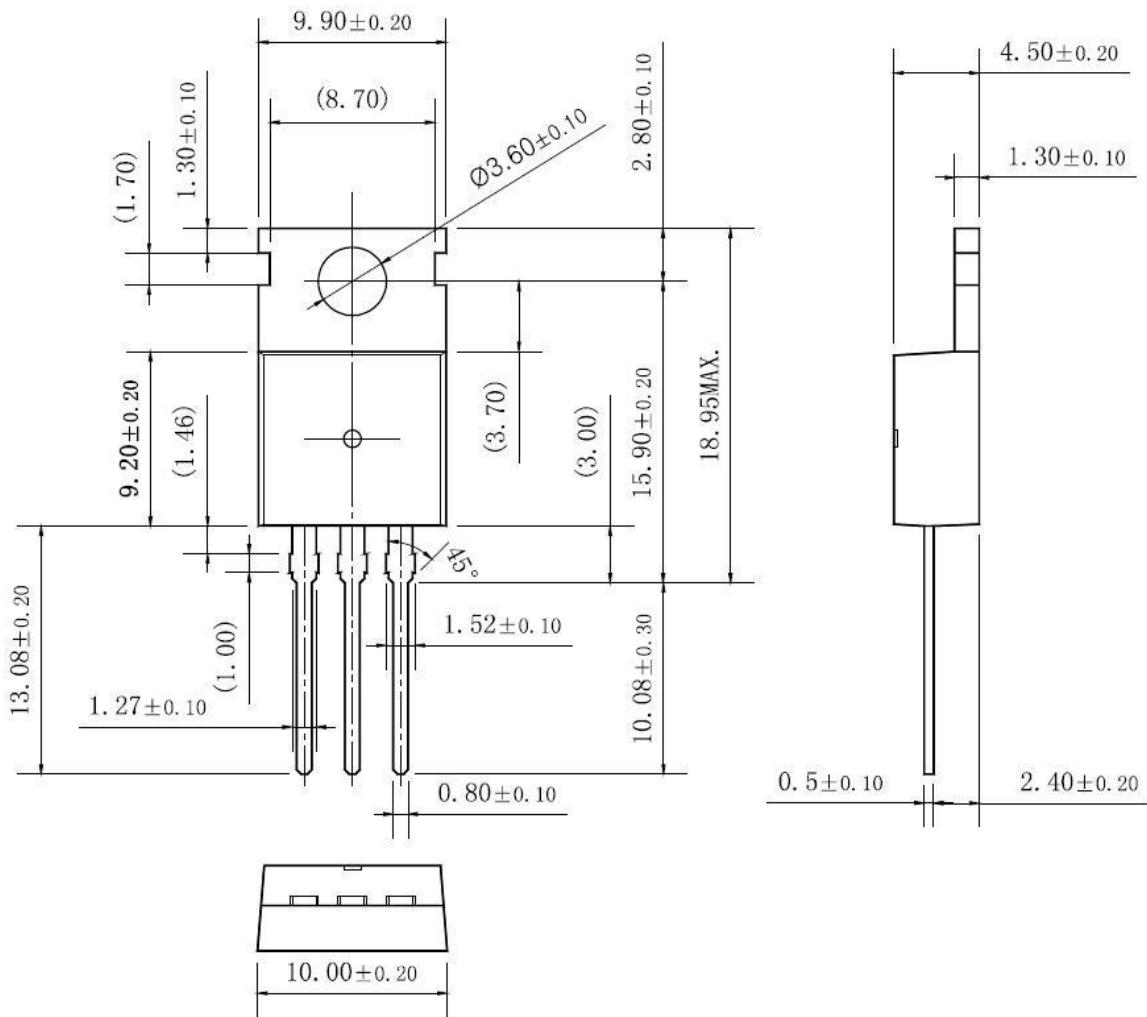


Fig. 11. Maximum Drain Current vs. Temperature



**Package Dimensions**
**TO-220**

(Dimensions in Millimeters)



## Package Dimensions

**TO-220F**

(Dimensions in Millimeters)

